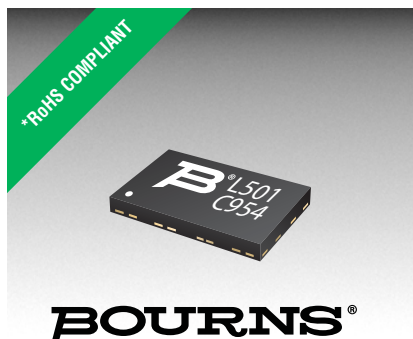




Features

- Superior circuit protection
- Overcurrent & overvoltage protection
- Blocks surges up to rated limits
- High speed performance
- Small SMT package
- RoHS compliant*
- Agency recognition: 

Applications

- SLIC protection
- Cable & DSL
- MDU/MTU modems
- ONT
- Voice/DSL line cards

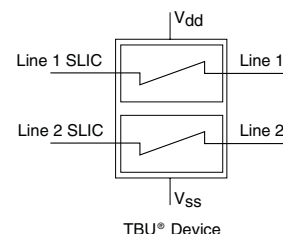
TBU-PL Series - TBU® High Speed Protectors

General Information

The TBU-PL Series of Bourns® TBU® products are low capacitance dual bidirectional high speed protection components, constructed using MOSFET semiconductor technology, and designed to protect against faults caused by short circuits, AC power cross, induction and lightning surges.

In addition to overcurrent protection, an added feature is the voltage monitoring on the two lines. If the voltage on the line drops below V_{SS} then the voltage will trigger the device to switch to the blocking state.

The TBU® high speed protector placed in the system circuit will monitor the current with the MOSFET detection circuit triggering to provide an effective barrier behind which sensitive electronics will not be exposed to large voltages or currents during surge events. The TBU® device is provided in a surface mount DFN package and meets industry standard requirements such as RoHS and Pb Free solder reflow profiles.



Agency Approval

Description	
UL	File Number: E315805

Industry Standards (in Conjunction with OVP Device)

Solutions available for GR-1089-CORE, ITU-T and a combination of both.

Absolute Maximum Ratings (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Part Number	Value	Unit
V_{imp}	Peak impulse voltage withstand with duration less than 10 ms	TBU-PL050-xxx-WH	500	V
		TBU-PL060-xxx-WH	600	
		TBU-PL075-xxx-WH	750	
		TBU-PL085-xxx-WH	850	
V_{rms}	Continuous A.C. RMS voltage	TBU-PL050-xxx-WH	300	V
		TBU-PL060-xxx-WH	350	
		TBU-PL075-xxx-WH	400	
		TBU-PL085-xxx-WH	425	
T_{op}	Operating temperature range		-55 to +125	$^\circ\text{C}$
T_{stg}	Storage temperature range		-65 to +150	$^\circ\text{C}$
T_{jmax}	Maximum Junction Temperature		+125	$^\circ\text{C}$
ESD	HBM ESD Protection per IEC 61000-4-2 on line pads		± 2	kV

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Part Number	Min.	Typ.	Max.	Unit
$I_{trigger}$	Current required for the device to go from operating state to protected state	TBU-PLxxx-100-WH	100	150	200	mA
		TBU-PLxxx-200-WH	200	300	400	
R_{device}	Series resistance of the TBU® device		40	50	55	Ω
R_{match}	Package resistance matching of the TBU® device #1 - TBU® device #2			± 0.5	± 1.0	Ω
t_{block}	Time taken for the device to go into current limiting				1	μs
I_Q	Current through the triggered TBU® device with 50 Vdc circuit voltage		0.25	0.70	1.50	mA
I_{ss}	Operating current with $V_{SS} = -50\text{ V}$			100		μA
V_{reset}	Voltage below which the triggered TBU® device will transition to normal operating state	TBU-PLxxx-100-WH	12	15	22	V
		TBU-PLxxx-200-WH	15	20	25	
V_{to}	Voltage threshold offset with 60 Hz applied voltage, with $V_{SS} = -50\text{ V}$ ($V_{SS} - V_{lineSLIC}$)		-1.0		0.2	V
V_{SS}	Operating voltage range relative to V_{dd}		-180		-20	V
$R_{th(j-l)}$	Junction to package pads - FR4 using minimum recommended pad layout			65		$^\circ\text{C/W}$
$R_{th(j-l)}$	Junction to package pads - FR4 using heat sink on board (6 cm ²) (0.5 in. ²)			40		$^\circ\text{C/W}$

*RoHS Directive 2002/95/EC Jan 27, 2003 including Annex.

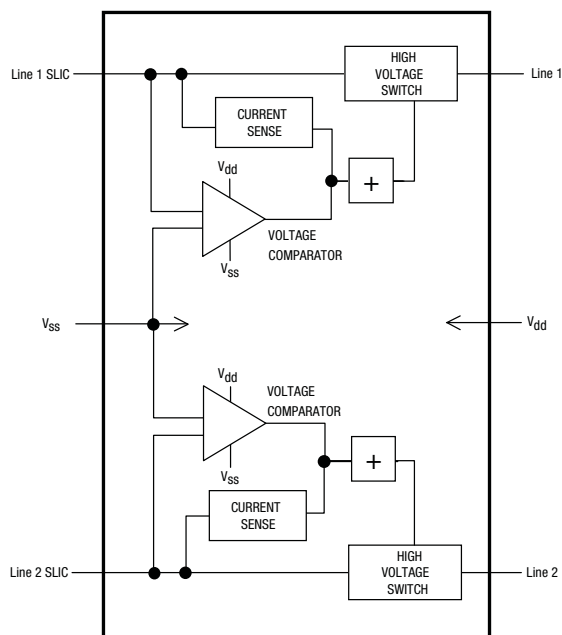
Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.

TBU-PL Series - TBU® High Speed Protectors

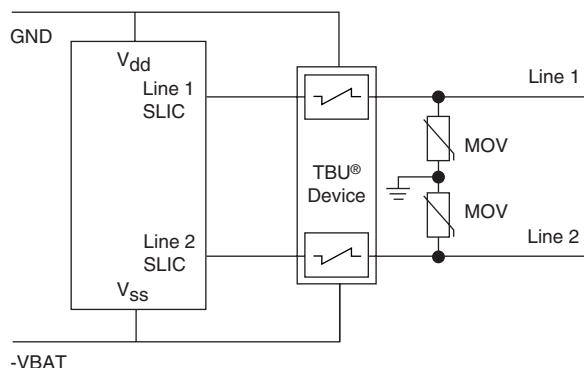
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Functional Block Diagram



Reference Application

The TBU-PL Series are high-speed protectors used in voice/VoIP SLIC applications. The maximum voltage rating of the TBU® device should never be exceeded. Where necessary, an OVP device should be employed to limit the maximum voltage. A cost-effective protection solution combines Bourns® TBU® protection devices with a pair of Bourns® MOVs. For bandwidth sensitive applications, a Bourns® GDT may be substituted for the MOV.



Basic TBU Operation

The TBU® device, constructed using MOSFET semiconductor technology, placed in the system circuit will monitor the current with the MOSFET detection circuit triggering to provide an effective barrier behind which sensitive electronics are not exposed to large voltages or currents during surge events. The TBU® device operates in approximately 1 μ s - once line current exceeds the TBU® device's trigger current $I_{trigger}$. When operated, the TBU® device restricts line current to less than 1 mA typically. When operated, the TBU® device will block all voltages including the surge up to rated limits.

When the voltage on the SLIC output is driven below ($V_{bat} - V_{to}$) the TBU-PL series device switches to the blocking state, regardless of output current in the device.

After the surge, the TBU® device resets when the voltage across the TBU® device falls to the V_{reset} level. The TBU® device will automatically reset on lines which have no DC bias or have DC bias below V_{reset} (such as unpowered signal lines).

If the line has a normal DC bias above V_{reset} , the voltage across the TBU® device may not fall below V_{reset} after the surge. In such cases, special care needs to be taken to ensure that the TBU® device will reset, with software monitoring as one method used to accomplish this. Bourns application engineers can provide further assistance.

TBU-PL Series - TBU® High Speed Protectors

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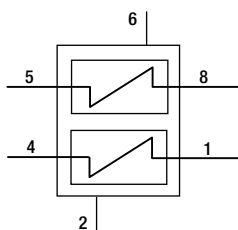
Bourns® TBU® Device Solution

Industry Standard	Surge & AC Tests	TBU® Device P/N	Qty.	OVP Device P/N	Qty.
Telcordia GR-1089-CORE Intra-building	1500 V, 100 A 2/10 μ s 120 V RMS, 25 A, 900 s	TBU-PL050-xxx-WH	1	MOV-07D201K	2
Telcordia GR-1089-CORE Enhanced Intra-building	5000 V, 500 A 2/10 μ s 120 V RMS, 25 A, 900 s	TBU-PL060-xxx-WH	1	MOV-10D201K	2
	1500 V, 100 A 2/10 μ s 277 V RMS, 25 A, 900 s	TBU-PL085-xxx-WH	1	MOV-10D431K	2
ITU-T K.20, K.21, K.45 Basic	1500 V, 40 Ω 10/700 μ s 4000 V, 40 Ω 10/700 μ s 230 V rms 10 Ω -1000 Ω , 900 s 600 V rms 600 Ω , 1 s	TBU-PL060-xxx-WH	1	TISP4400M3BJ	2
	1500 V, 40 Ω 10/700 μ s 4000 V, 40 Ω 10/700 μ s 230 V rms 10 Ω -1000 Ω , 900 s 600 V rms 600 Ω , 0.2 s	TBU-PL075-xxx-WH	1	MOV-10D361K	2
ITU-T K.20, K.21, K.45 Enhanced	1500 V, 40 Ω 10/700 μ s 6000 V, 40 Ω 10/700 μ s 230 V rms 10 Ω -1000 Ω , 900 s 600 V rms 600 Ω , 0.2 s 600 V rms 600 Ω , 1 s 1500 V rms, 200 Ω 2s	TBU-PL060-xxx-WH	1	TISP4500H3BJ	2
	1500 V, 40 Ω 10/700 μ s 6000 V, 40 Ω 10/700 μ s* 230 V rms 10 Ω -1000 Ω , 900 s 600 V rms 600 Ω , 0.2 s 600 V rms 600 Ω , 1 s* 1500 V rms, 200 Ω 2s*	TBU-PL085-xxx-WH	1	MOV-10D391K	2
Telcordia GR-1089-CORE Intra-building and ITU-T K.20, K.21, K.45 Enhanced	5000 V, 500 A 2/10 μ s 120V RMS, 25 A, 900 s 1500 V, 40 Ω 10/700 μ s 6000 V, 40 Ω 10/700 μ s* 230 V rms 10 Ω -1000 Ω , 900 s 600 V rms 600 Ω , 0.2 s 600 V rms 600 Ω , 1 s* 1500 V rms, 200 Ω 2s*	TBU-PL085-xxx-WH	1	MOV-10D391K	2

* GDT Special Test Protector with DC breakdown (DCBD) of less than 330 V.

Note: The Le9500, Le9520 and Le9530 (VE950 series) require a 200 mA I_{trigger} TBU® device for normal operation.

Device Pin Out



Pad Designation

Pad #	Pin Out
1	Line 1
2	V _{dd}
3	Not Used
4	Line 1 SLIC

Pad #	Pin Out
5	Line 2 SLIC
6	V _{ss}
7	Not Used
8	Line 2

Specifications are subject to change without notice.

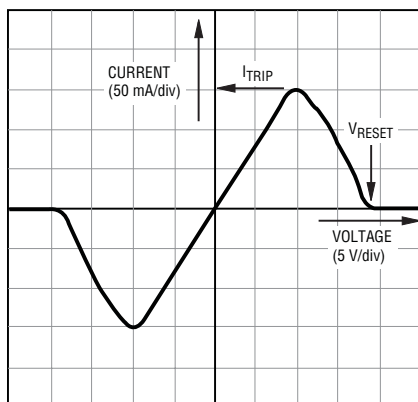
Customers should verify actual device performance in their specific applications.

TBU-PL Series - TBU® High Speed Protectors

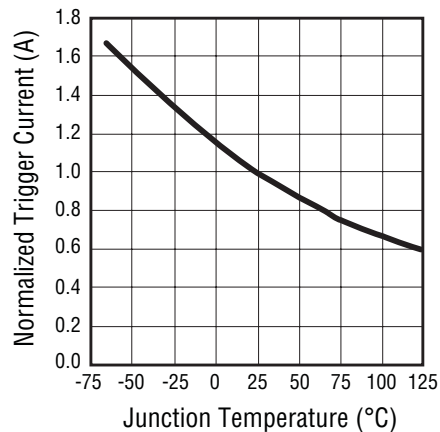
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Performance Graphs

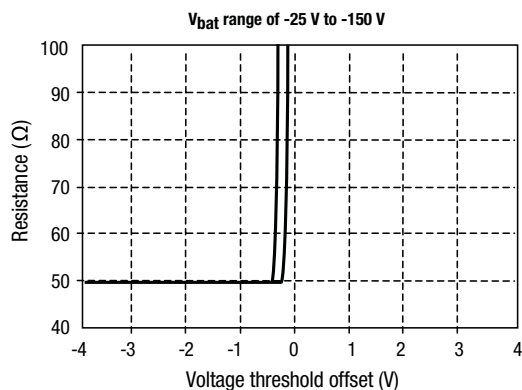
Typical V-I Characteristics (TBU-PL085-200-WH)



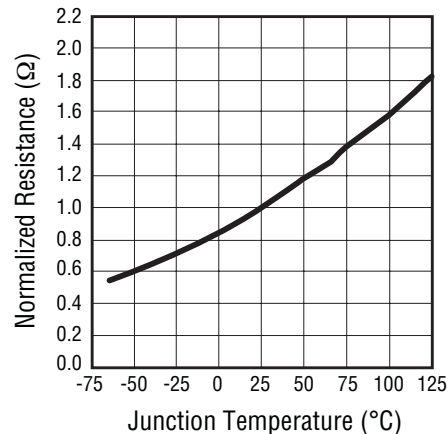
Typical Trigger Current vs. Temperature



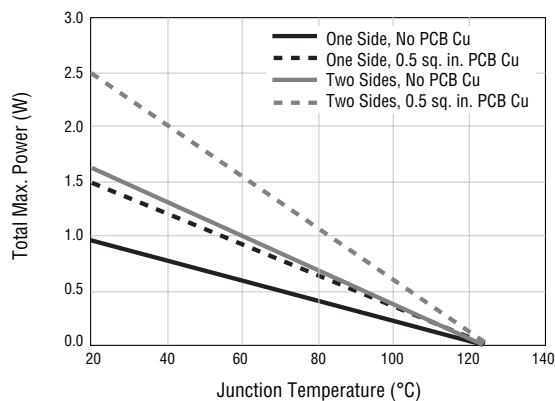
Tracking Voltage Characteristics



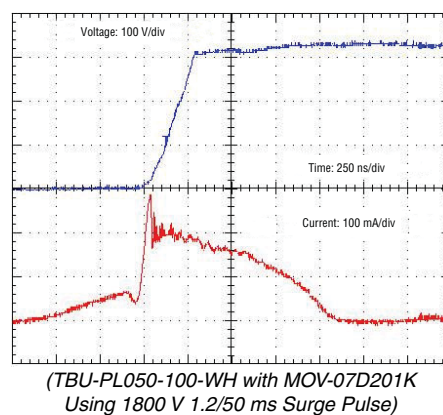
Typical Resistance vs. Temperature



Power Derating Curve



Typical Surge Response



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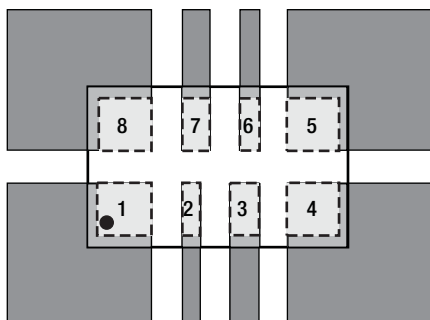
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The drawing illustrates the mechanical specifications of a 16-pin DIP package. It includes three views: a top view, a side view, and a bottom view.

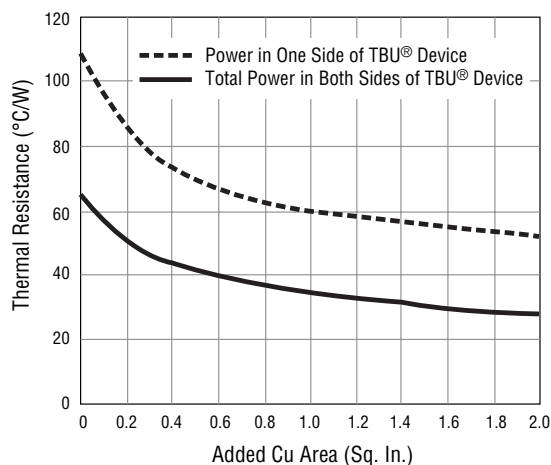
- Top View:** Shows the package footprint with a width of 6.50 mm (.256 inches) and a height of 4.00 mm (.157 inches). The pin pitch is 0.85 mm (.033 inches). The package is marked with a stylized 'B' logo, 'XXXX', and 'YYYY'. A note points to 'PIN 1 & BACKSIDE CHAMFER'.
- Side View:** Shows the package height with dimensions for the body (0.80 - 0.95 mm (.031 - .037 inches)) and the lead thickness (0.00 - 0.05 mm (.000 - .002 inches)).
- Bottom View:** Shows the pin layout with dimensions for the pin pitch (0.85 mm (.033 inches)), the distance from the package edge to the first pin (0.90 mm (.035 inches)), and the distance between pins (0.00 - 0.05 mm (.000 - .002 inches)).

DIMENSIONS: MM (INCHES)

TBU® protectors have matte-tin termination finish. The suggested layout should use Non-Solder Mask Define (NSMD). The recommended stencil thickness is 0.10-0.12 mm (.004-.005 in.) with a stencil opening size 0.025 mm (.0010 in.) less than the device pad size. As when heat sinking any power device, it is recommended that wherever possible, extra PCB copper area is allowed. For minimum parasitic capacitance, do not allow any signal, ground or power signals beneath any of the pads of the device.



Thermal Resistance vs Additional PCB Cu Area



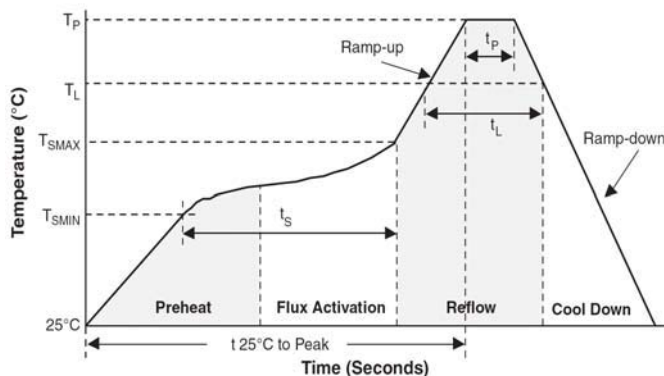
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TBU-PL Series - TBU® High Speed Protectors

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Reflow Profile

Profile Feature	Pb-Free Assembly
Average Ramp-Up Rate (T _{smax} to T _p)	3 °C/sec. max.
Preheat - Temperature Min. (T_{sm}) - Temperature Max. (T_{smax}) - Time (t_{sm} to t_{smax})	150 °C 200 °C 60-180 sec.
Time maintained above: - Temperature (T_L) - Time (t_L)	217 °C 60-150 sec.
Peak/Classification Temperature (T _p)	260 °C
Time within 5 °C of Actual Peak Temp. (t _p)	20-40 sec.
Ramp-Down Rate	6 °C/sec. max.
Time 25 °C to Peak Temperature	8 min. max.



How to Order

TBU - PL 085 - 100 - WH

TBU® Product _____

Series _____
 PL = Dual Bidirectional Series

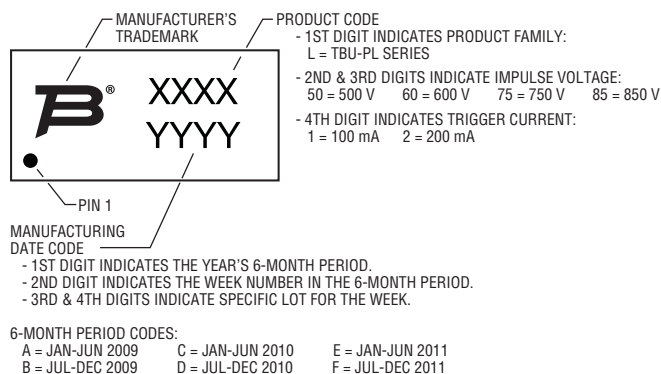
Impulse Voltage Rating _____
 050 = 500 V
 060 = 600 V
 075 = 750 V
 085 = 850 V

Trigger Current _____
 100 = 100 mA
 200 = 200 mA

Hold to Trip Ratio Suffix _____
 W = Hold to Trip Ratio

Package Suffix _____
 H = DFN Package

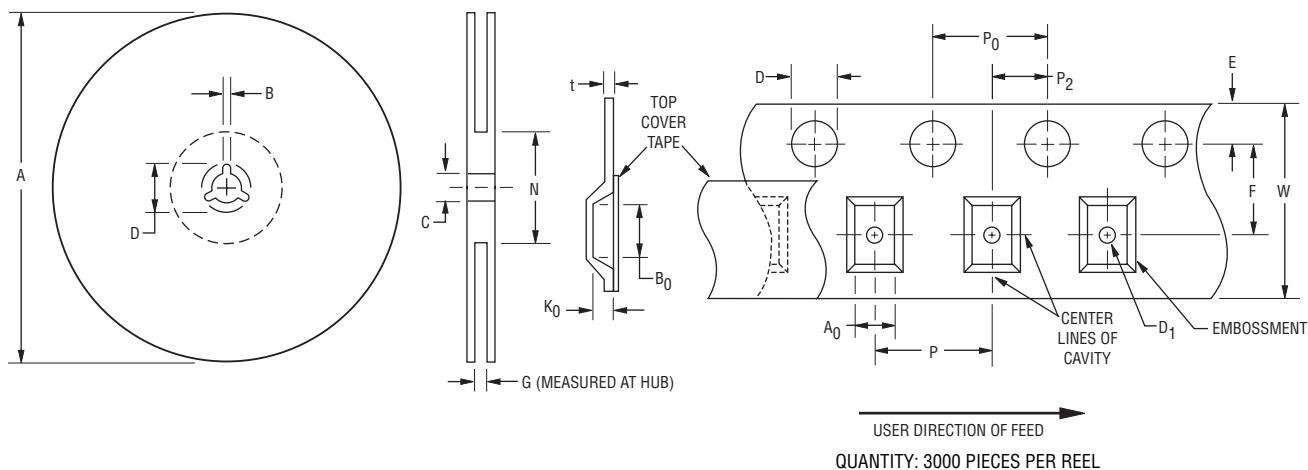
Typical Part Marking



TBU-PL Series - TBU® High Speed Protectors

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Packaging Specifications



A		B		C		D		G	N
Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Ref.	Ref.
326	330	1.5	2.5	12.8	13.5	20.2	-	16.5	102
(12.835)	(13.002)	(.059)	(.098)	(.504)	(.531)	(.795)		(.650)	(4.016)

A0		B0		D		D1		E		F	
Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
4.30	4.50	6.70	6.90	1.5	1.6	1.5	-	1.65	1.85	7.4	7.6
(.169)	(.177)	(.264)	(.272)	(.059)	(.063)	(.059)		(.065)	(.073)	(.291)	(.299)
K0		P		P0		P2		t		W	
Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.
1.0	1.2	7.9	8.1	3.9	4.1	1.9	2.1	0.25	0.35	15.7	16.3
(.039)	(.047)	(.311)	(.319)	(.159)	(.161)	(.075)	(.083)	(.010)	(.014)	(.618)	(.642)

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

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REV. 01/11

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